CRMCTH1017A

N-Channel 100V, 9.9mΩ Typ. Power MOSFET

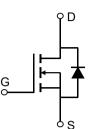
Description

Features

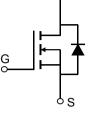
• 100V, 75A

$$R_{DS(ON)}$$
 Typ = 9.9m Ω @ V_{GS} = 10 V

- Advanced Trench Technology
- Excellent R_{DS(ON)} and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!

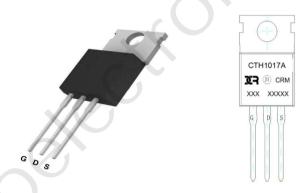






Application

- Load Switch
- PWM Application
- **Power Management**



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	TUBE(pcs)	Inner Box (pcs)	Per Carton (pcs)
CRMCTH1017A	CRMCTH1017A	TO-220C-3L	TUBE	50	1000	5000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		100	V
V_{GS}	Gate-to-Source Voltage		±20	V
,	Continuous Drain Current	T _C = 25°C	75	А
I _D	Continuous Diain Current	T _C = 100°C	45	А
I _{DM}	Pulsed Drain Current (1)		300	А
E _{AS}	Single Pulsed Avalanche Energy (2)		272	mJ
P_{D}	Power Dissipation	T _C = 25°C	125	W
$R_{ heta JC}$	Thermal Resistance, Junction to Case		1	°C/W
T_{J} , T_{STG}	Junction & Storage Temperature Rang	e	-55 to 150	°C



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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 100V, V _{GS} = 0V	-	-	1.0	μΑ
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.4	2.8	3.6	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	$V_{GS} = 10V, I_D = 30A$	-	9.9	12.8	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		- /	7355	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 25V,$ f = 1MHz	-	320	-	pF
C_{rss}	Reverse Transfer Capacitance	I – TIVINZ	X - \	252	-	pF
Q_g	Total Gate Charge		-	128	-	nC
Q_{gs}	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 50V, I_{D} = 25A$	<u> </u>	30	-	nC
Q_{gd}	Gate Drain("Miller") Charge	V _{DS} - 30 V, I _D - 23A	-	38	-	nC
Switchin	g Characteristics					
t _{d(on)}	Turn-On DelayTime		-	30	-	ns
t_r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 50V$	-	48	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	I_D = 25A, R_{GEN} = 5Ω	-	80	-	ns
t _f	Turn-Off Fall Time		-	50	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
I _S	Maximum Continuous Drain to Source Di	ode Forward Current	-	-	75	Α
I _{SM}	Maximum Pulsed Drain to Source Diode	Forward Current	-	-	300	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S = 30A	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	L 054 11/11 10041	-	69	-	ns
Qrr	Body Diode Reverse Recovery Charge	$I_F = 25A$, di/dt = 100A/us	-	210	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =50V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =33A

^{3.} Pulse Test: Pulse Width $\!\!\leqslant\! 300\mu s,$ Duty Cycle $\!\!\leqslant\! 0.5\%.$



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Test Circuit

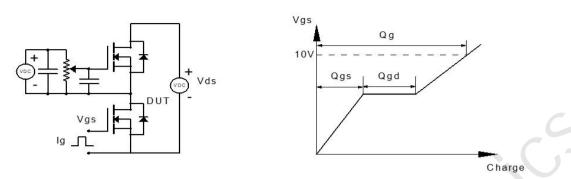


Figure 1: Gate Charge Test Circuit & Waveform

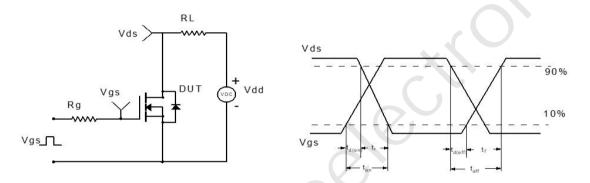


Figure 2: Resistive Switching Test Circuit & Waveform

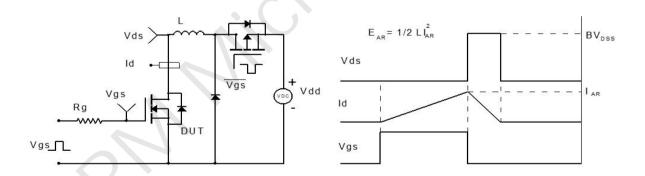


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

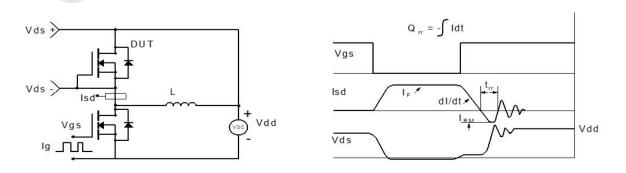
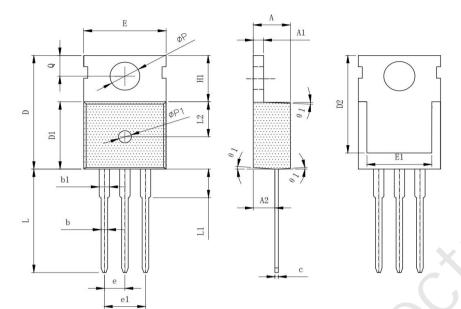


Figure 4: Diode Recovery Test Circuit & Waveform

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Package Mechanical Data(TO-220C-3L)



SYMBOL	MI	LLIMETER		
SIMBUL	MIN	NOM	MAX	
A	4. 40	4. 50	4.60	
A1	1. 25	1. 30	1.35	
A2	2. 30	2.40	2.50	
b	0.70	0.80	0.90	
b1	1. 25	1. 25 1. 35		
С	0. 40	0. 50	0.60	
D	15. 50	15. 80	16. 10	
D1	9. 10 9. 2		9. 30	
D2	12. 73	12.83	12.93	
E	9. 70	9. 90	10. 20	
E1	7. 60	8. 00	8. 40	
е	2. 54 (BSC)			
e1	5. 08 (BSC)			
H1	6. 30	6. 50	6.80	
L	12. 75	13. 08	13. 50	
L1	10		3. 10	
L2	4. 30	4. 60	4. 90	
ΦP	3. 50	3. 60	3. 70	
ØP1	1.40	1.50	1.60	
α	2. 70	1-21	2. 90	
θ 1	2°	4°	6°	

NOTES: 1. PKG SURFACE IS MATTE Ral. 2~1.4; OTHERS IS POLISHED RaO. 15:

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